

RS1E150GN

| V <sub>DSS</sub>           | 30V   |
|----------------------------|-------|
| R <sub>DS(on)</sub> (Max.) | 8.8mΩ |
| I <sub>D</sub>             | ±40A  |
| P <sub>D</sub>             | 22W   |

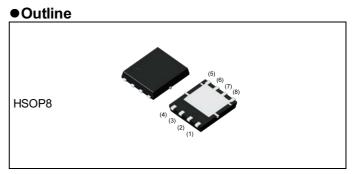
## Features

- 1) Low on resistance.
- 2) High power package (HSOP8).
- 3) Pb-free lead plating ; RoHS compliant
- 4) Halogen free

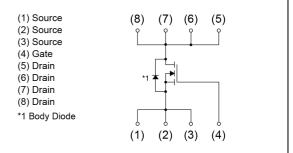
Application

Switching

5) 100% Rg and UIS tested.



#### Inner circuit



# Packaging specifications

|      | Packing                   | Embossed<br>Tape |
|------|---------------------------|------------------|
|      | Reel size (mm)            | 330              |
| Туре | Tape width (mm)           | 12               |
|      | Basic ordering unit (pcs) | 2500             |
|      | Taping code               | ТВ               |
|      | Marking                   | RS1E150GN        |

## • Absolute maximum ratings (T<sub>a</sub> = 25°C ,unless otherwise specified)

|                                   | 5                     | -                            |      |    |
|-----------------------------------|-----------------------|------------------------------|------|----|
| Parameter                         | Symbol                | Value                        | Unit |    |
| Drain - Source voltage            | V <sub>DSS</sub>      | 30                           | V    |    |
| Continuous drain surront          | $T_c = 25^{\circ}C$   | ۱ <sub>D</sub> *1            | ±40  | А  |
| Continuous drain current          | T <sub>a</sub> = 25°C | Ι <sub>D</sub>               | ±15  | А  |
| Pulsed drain current              | ۱ <sub>DP</sub> *2    | ±60                          | А    |    |
| Gate - Source voltage             | V <sub>GSS</sub>      | ±20                          | V    |    |
| Avalanche current, single pulse   | I <sub>AS</sub> *3    | 15                           | А    |    |
| Avalanche energy, single pulse    | E <sub>AS</sub> *3    | 17                           | mJ   |    |
| Power dissipation                 |                       | P <sub>D</sub> <sup>*1</sup> | 22   | W  |
|                                   |                       | P <sub>D</sub> <sup>*4</sup> | 3.0  | W  |
| Junction temperature              |                       | Tj                           | 150  | °C |
| Operating junction and storage te | T <sub>stg</sub>      | -55 to +150                  | °C   |    |

## Thermal resistance

| Deremeter                              | Sumbol          | Values |      |      | Linit |
|--|-----------------|--------|------|------|-------|
| Parameter                              | Symbol          | Min.   | Тур. | Max. | Unit  |
| Thermal resistance, junction - case    | $R_{thJC}^{*1}$ | -      | -    | 5.6  | °C/W  |
| Thermal resistance, junction - ambient | $R_{thJA}^{*4}$ | -      | -    | 41.7 | °C/W  |

## • Electrical characteristics (T<sub>a</sub> = 25°C)

| Deverseter  | Symbol                                   |  |      | Values |      | 1.1:4 |
|---|--|--|------|--------|------|-------|
| Parameter Symbol  |  | Conditions   | Min. | Тур.   | Max. | Unit  |
| Drain - Source breakdown<br>voltage   | $V_{(BR)DSS}$ $V_{GS}$ = 0V, $I_D$ = 1mA |  | 30   | -      | -    | V     |
| Breakdown voltage<br>temperature coefficient  | $\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$  | $\frac{\Delta V_{(BR)DSS}}{\Delta T_{i}} I_{D} = 1 \text{mA}$ referenced to 25°C |      | 28     | -    | mV/°C |
| Zero gate voltage<br>drain current  | I <sub>DSS</sub>                         | $I_{DSS}$ $V_{DS} = 24V, V_{GS} = 0V$  |      | -      | 1    | μA    |
| Gate - Source leakage current   | I <sub>GSS</sub>                         | $I_{GSS}$ $V_{GS} = \pm 20V, V_{DS} = 0V$  |      | -      | ±100 | nA    |
| Gate threshold voltage  | $V_{GS(th)}$                             | $V_{DS} = V_{GS}$ , $I_D = 1mA$  | 1.2  | -      | 2.5  | V     |
| Gate threshold voltage<br>temperature coefficient $\Delta V_{GS(th)}$<br>$\Delta T_i$ |  | I <sub>D</sub> = 1mA<br>referenced to 25°C                                       | -    | -3.87  | -    | mV/°C |
| Static drain - source   | D *5                                     | V <sub>GS</sub> = 10V, I <sub>D</sub> = 15A                                      | -    | 6.7    | 8.8  |       |
| on - state resistance   | $R_{DS(on)}^{*5}$                        | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 15A                                     | -    | 8.8    | 13.3 | mΩ    |
| Gate resistance   | R <sub>G</sub> f=1MHz, open drain        |  | -    | 2.3    | -    | Ω     |
| Forward Transfer $ Y_{fs} ^{*5}$ $V_{DS} = 5V, I_D = 15A$                             |  | 10.0   | -    | -      | S    |       |

\*1 Tc =  $25^{\circ}$ C, Limited only by maximum temperature allowed.

\*2 Pw $\leq$ 10µs , Duty cycle $\leq$ 1%

\*3 L  $\simeq$  0.1mH, V\_{DD} = 15V, R\_G = 25 $\Omega$ , STARTING T\_j = 25°C Fig.3-1,3-2

- \*4 Mounted on a Cu board (40×40×0.8mm)
- \*5 Pulsed





# •Electrical characteristics (T<sub>a</sub> = 25°C)

| Deremeter                                     | Cumph of              | Conditions                        | Values |      |      | Unit |  |
|---|-----------------------|-----------------------------------|--------|------|------|------|--|
| Parameter                                     | Symbol Conditions -   |                                   | Min.   | Тур. | Max. | Unit |  |
| Input capacitance                             | C <sub>iss</sub>      | V <sub>GS</sub> = 0V              | -      | 590  | -    |      |  |
| Output capacitance                            | C <sub>oss</sub>      | V <sub>DS</sub> = 15V             | -      | 160  | -    | pF   |  |
| Reverse transfer capacitance C <sub>rss</sub> |                       | f = 1MHz                          | -      | 44   | -    |      |  |
| Turn - on delay time                          | t <sub>d(on)</sub> *5 | $V_{DD} \simeq 15V, V_{GS} = 10V$ | -      | 9.6  | -    |      |  |
| Rise time                                     | t <sub>r</sub> *5     | I <sub>D</sub> = 7.5A             | -      | 4.5  | -    |      |  |
| Turn - off delay time $t_{d(off)}^{*5}$       |                       | $R_L \simeq 2.0\Omega$            | -      | 25.5 | -    | ns   |  |
| Fall time                                     | t <sub>f</sub> *5     | R <sub>G</sub> = 10Ω              | -      | 3.4  | -    |      |  |

# • Gate charge characteristics ( $T_a = 25^{\circ}C$ )

| Deremeter            | Sumbol             | Conditions           |                        | Values |      |      | l lait |  |
|----------------------|--------------------|----------------------|------------------------|--------|------|------|--------|--|
| Parameter            | Symbol             |                      |                        | Min.   | Тур. | Max. | Unit   |  |
| Total gata abarga    | O *5               |                      | V <sub>GS</sub> = 10V  | -      | 10.0 | -    |        |  |
| Total gate charge    | $Q_g^{*5}$         |                      | V <sub>DD</sub> ≃ 15V  |        | -    | 4.8  | -      |  |
| Gate - Source charge | Q <sub>gs</sub> *5 | I <sub>D</sub> = 15A | V <sub>GS</sub> = 4.5V | -      | 2.3  | -    | nC     |  |
| Gate - Drain charge  | Q <sub>gd</sub> *5 |                      |                        | -      | 1.1  | -    |        |  |

## •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

| Deremeter                  | Symbol Conditions  |   | Values |      |      | Unit |
|----------------------------|--------------------|---|--------|------|------|------|
| Parameter                  | Symbol             | Conditions                                  | Min.   | Тур. | Max. | Unit |
| Continuous forward current | I <sub>S</sub>     | T <sub>a</sub> = 25℃                        | -      | -    | 2.5  | А    |
| Pulse forward current      | I <sub>SP</sub> *2 | $T_a = 25 C$                                | -      | -    | 60   | А    |
| Forward voltage            | V <sub>SD</sub> *5 | V <sub>GS</sub> = 0V, I <sub>S</sub> = 2.5A | -      | -    | 1.2  | V    |
| Reverse recovery time      | t <sub>rr</sub> *5 | I <sub>S</sub> = 15A, V <sub>GS</sub> =0V   | -      | 21.4 | -    | ns   |
| Reverse recovery charge    | Q <sub>rr</sub> *5 | di/dt = 100A/µs                             | -      | 11.8 | -    | nC   |





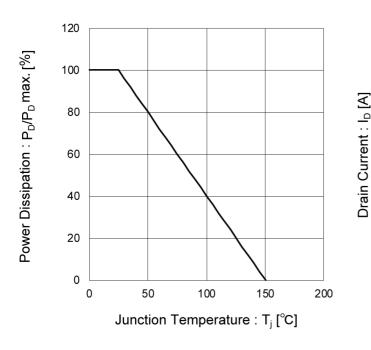


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

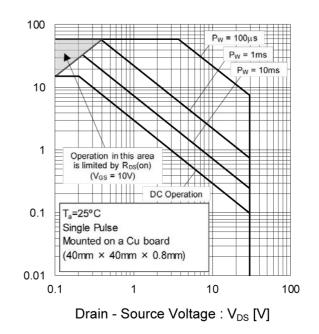
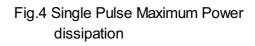
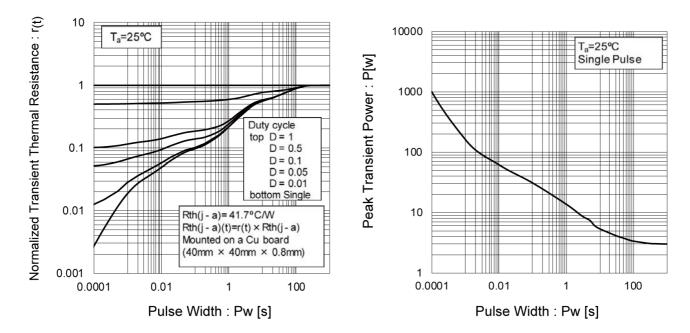


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

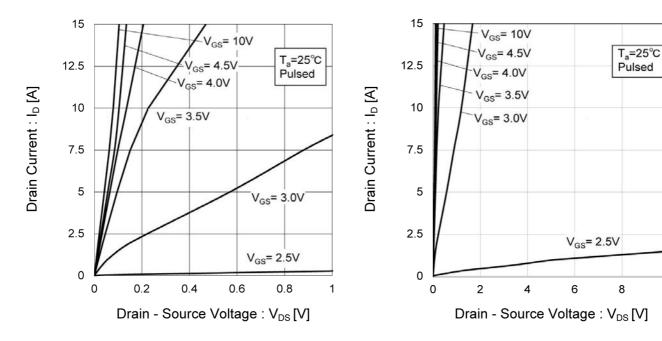








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## Fig.5 Typical Output Characteristics(I)

Fig.7 Breakdown Voltage vs. Junction Temperature

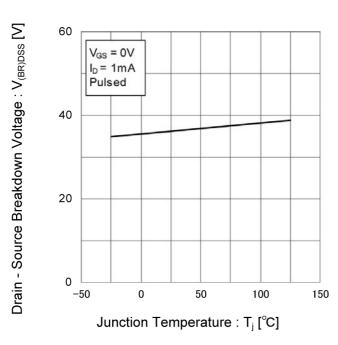
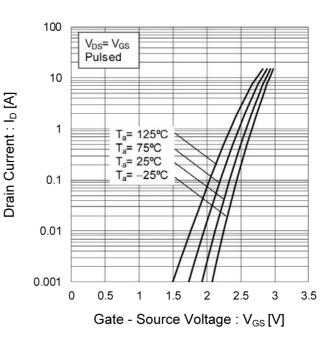


Fig.8 Typical Transfer Characteristics

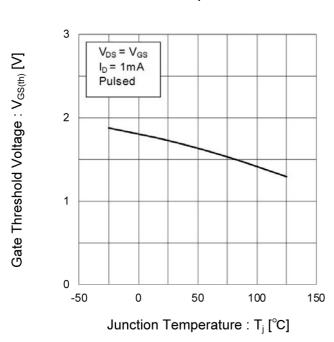
Fig.6 Typical Output Characteristics(II)



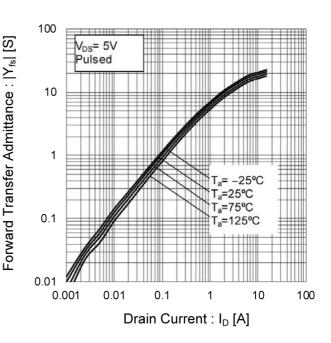




## • Electrical characteristic curves



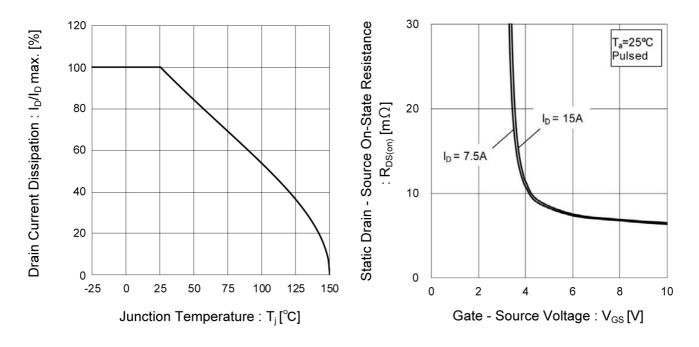
## Fig.9 Gate Threshold Voltage vs. Junction Temperature



## Fig.10 Forward Transfer Admittance vs. Drain Current

Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage





## • Electrical characteristic curves

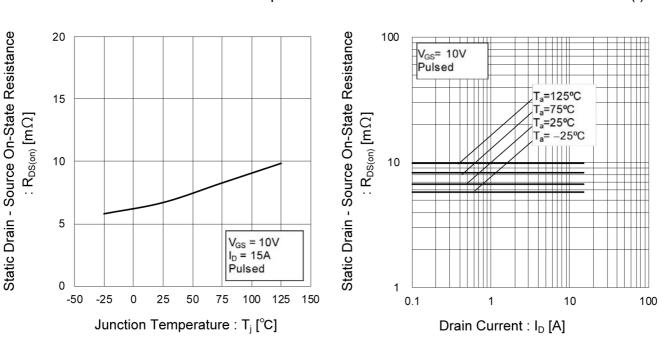
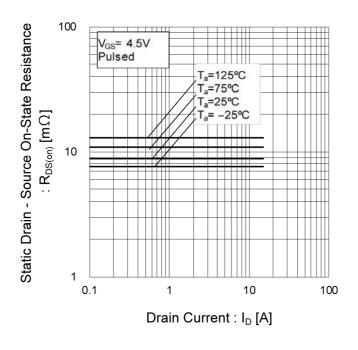


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)





## • Electrical characteristic curves

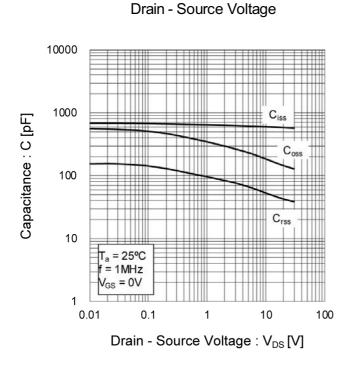


Fig.16 Typical Capacitance vs.

## Fig.17 Switching Characteristics

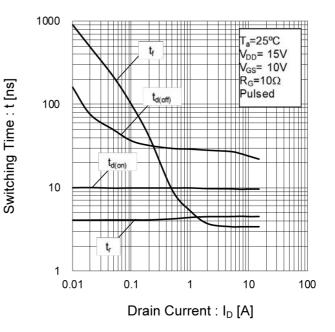


Fig.18 Dynamic Input Characteristics

Gate - Source Voltage : V<sub>GS</sub> [V]

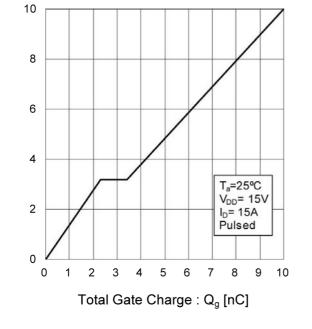
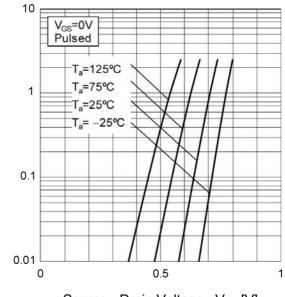


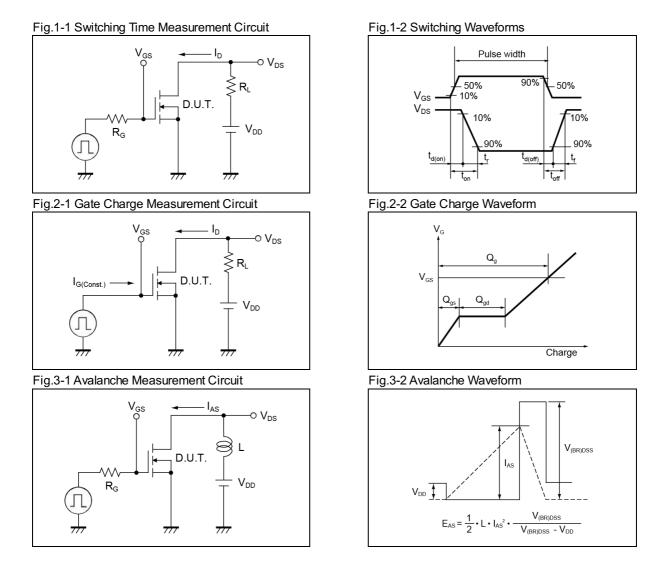
Fig.19 Source Current vs. Source Drain Voltage



Source Current : I<sub>s</sub> [A]



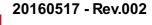
#### Measurement circuits



## Notice

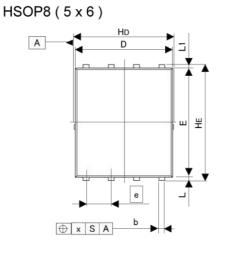
This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

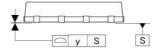


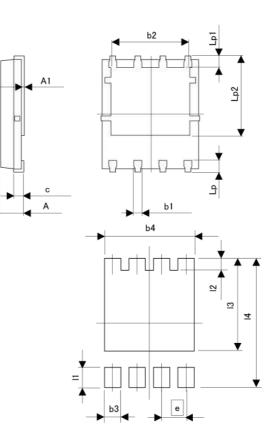


ROHM

#### Dimensions







Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM - | MILIMETERS     |      | INC             | HES   |
|-------|----------------|------|-----------------|-------|
|       | MIN            | MAX  | MIN             | MAX   |
| A     | 0.90           | 1.10 | 0.035           | 0.043 |
| A1    | 0.00           | 0.05 | 0.000           | 0.002 |
| b     | 0.24           | 0.42 | 0.009           | 0.017 |
| b1    | 0.29           | 0.49 | 0.011           | 0.019 |
| b2    | 3.81           | 4.21 | 0.150           | 0.166 |
| С     | 0.20           | 0.30 | 0.008           | 0.012 |
| D     | 4.80           | 5.00 | 0.189           | 0.197 |
| E     | 5.60           | 5.80 | 0.220           | 0.228 |
| e     | 1.             | 27   | 0.0             | )50   |
| HD    | 4.90           | 5.10 | 0.193           | 0.201 |
| HE    | 5.90           | 6.10 | 0.232           | 0.240 |
| L     | 0.07           | 0.25 | 0.003           | 0.010 |
| L1    | 0.07           | 0.25 | 0.003           | 0.010 |
| Lp    | 0.50           | 0.70 | 0.020           | 0.028 |
| Lp1   | 0.52           | 0.72 | 0.020           | 0.028 |
| Lp2   | 3.92           | 4.32 | 0.154           | 0.170 |
| x     | 2              | 0.10 | -               | 0.004 |
| у     | -              | 0.10 |                 | 0.004 |
|       | MILIME         | TERS | INC             | HES   |
| DIM   | MIN            | MAX  | MIN             | MAX   |
| b3    | i <del>n</del> | 0.59 | 200             | 0.023 |
| b4    | 4              | 4.21 | 1.41            | 0.166 |
| 11    | 2              | 0.80 | .) ( <u>a</u> : | 0.031 |
| 12    | -              | 0.82 |                 | 0.032 |
| 13    |                | 4.32 | 0.000           | 0.170 |
| 14    | 2              | 6.10 | 1.00            | 0.240 |

Dimension in mm/inches



# Notice

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|---|--------|---------|------------|---------|
| ſ | CLASSⅢ | CLASSⅢ  | CLASS II b | CLASSII |
|   | CLASSⅣ | CLASSIL | CLASSⅢ     | CLASSI  |

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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